

IN THE CLAIMS:

1. (Currently Amended) A display apparatus in which display operation is carried out by controlling emission of each pixel arranged in a matrix, the apparatus comprising:

an element substrate on which a luminous element is formed for each of the pixels;

a sealing substrate on which a protrusion is formed in a surrounding area thereof, the protrusion being adhered to the periphery of ~~said~~the element substrate so as to seal an upper space over ~~said~~the element substrate, and

a desiccant fixed on an internal surface of the sealing substrate opposed to the element substrate so as to make the upper space located over the element substrate dry, wherein

~~said~~the desiccant consists of an adhesive made of resin and moisture absorbent grains dispersedly mixed into the adhesive, the moisture absorbent grains are CaO grains having a grain size of 0.1 μm to 10 μm and a coefficient of thermal expansion of 5×10^{-6} to 25×10^{-6} , and the adhesive is a thermoplastic resin having a coefficient of thermal expansion of 100×10^{-6} to 200×10^{-6} . ~~and~~

~~the size of said moisture absorbent grains is equal to or smaller than 10 μm .~~

2-3. (Canceled)

4. (Currently Amended) A display apparatus according to claim ~~3~~ 1, wherein ~~said~~the thermoplastic resin is an acrylic resin or an epoxy resin.

5. (Canceled)

6. (Currently Amended) A display apparatus according to claim 1, wherein ~~said~~ the desiccant is formed in the shape of a spiral on a surface of the sealing substrate opposed to the element substrate, and the desiccant has a thickness of approximately 10 μm to 150 μm and a width of approximately 1000 μm to 2000 μm .

7. (Currently Amended) A desiccant which absorbs moisture consisting of:

an adhesive of resin, and

moisture absorbent grains dispersedly mixed into the adhesive, wherein

the moisture absorbent grains are CaO grains having a grain size of 0.1 μm to 10 μm and a coefficient of thermal expansion of 5×10^{-6} to 25×10^{-6} , and the adhesive is a thermoplastic resin having a coefficient of thermal expansion of 100×10^{-6} to 200×10^{-6} .

~~the diameter of said moisture absorbent grains is equal to or smaller than 10 μm .~~

8-9. (Canceled)

10. (Currently Amended) A desiccant according to claim—9_7, wherein thesaid thermoplastic resin is an acrylic resin or an epoxy resin.

11. (Canceled)